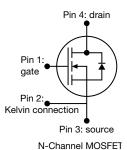
Vishay Siliconix

COMPLIANT

# **E Series Power MOSFET with Fast Body Diode**





| PRODUCT SUMMARY                            |                         |       |  |  |
|--|-------------------------|-------|--|--|
| V <sub>DS</sub> (V) at T <sub>J</sub> max. | 700                     |       |  |  |
| $R_{DS(on)}$ typ. ( $\Omega$ ) at 25 °C    | $V_{GS} = 10 \text{ V}$ | 0.332 |  |  |
| Q <sub>g</sub> max. (nC)                   | 70                      |       |  |  |
| Q <sub>gs</sub> (nC)                       | 8                       |       |  |  |
| Q <sub>gd</sub> (nC)                       | 15                      |       |  |  |
| Configuration                              | Single                  |       |  |  |

#### **FEATURES**

- · Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- · Reduced switching and conduction losses
- Ultra lo
- Avalan
- Kelvin o
- Materia please see www.vishay.com/doc?99912

| ow gate charge (Q <sub>g</sub> )                         | HALOGEN<br>FREE          |
|--|--------------------------|
| che energy rated (UIS) connection for reduced gate noise | <u>GREEN</u><br>(5-2008) |
| al categorization: for definitions of                    | compliance               |

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

| ORDERING INFORMATION            |                    |
|---------------------------------|--------------------|
| Package                         | PowerPAK 8 x 8     |
| Lead (Pb)-free and Halogen-free | SiHH11N65EF-T1-GE3 |

| ABSOLUTE MAXIMUM RATINGS (                         | Γ <sub>C</sub> = 25 °C, unless otherwi   | se noted)      |         |   |
|--|--|----------------|---------|---|
| PARAMETER  | SYMBOL   | LIMIT          | UNIT    |   |
| Drain-Source Voltage                               | $V_{DS}$   | 650            | V       |   |
| Gate-Source Voltage                                | $V_{GS}$   | ± 30           | 7 v     |   |
| Continuous Drain Current /T 150 °C\                | $V_{GS}$ at 10 V $T_{C} = 25 ^{\circ}\text{C}$<br>$T_{C} = 100 ^{\circ}\text{C}$ |                | 11      |   |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | $V_{GS}$ at 10 V $T_C = 100 ^{\circ}C$   | Ι <sub>D</sub> | 7       | Α |
| Pulsed Drain Current <sup>a</sup>                  | I <sub>DM</sub>  | 27             |         |   |
| Linear Derating Factor                             |  | 1              | W/°C    |   |
| Single Pulse Avalanche Energy <sup>b</sup>         | E <sub>AS</sub>  | 127            | mJ      |   |
| Maximum Power Dissipation                          | P <sub>D</sub>   | 130            | W       |   |
| Operating Junction and Storage Temperature Ra      | T <sub>J</sub> , T <sub>stg</sub>  | -55 to +150    | °C      |   |
| Drain-Source Voltage Slope                         | dV/dt  | 70             | V/ns    |   |
| Reverse Diode dV/dt <sup>c</sup>                   | uv/at  | 26             | ) v/ris |   |

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 3 A.
- c.  $I_{SD} \le I_D$ ,  $dI/dt = 100 \text{ A/}\mu\text{s}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ .



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| THERMAL RESISTANCE RATINGS       |                   |                         |      |      |  |
|----------------------------------|-------------------|-------------------------|------|------|--|
| PARAMETER                        | SYMBOL            | TYP.                    | MAX. | UNIT |  |
| Maximum Junction-to-Ambient      | R <sub>thJA</sub> | R <sub>thJA</sub> 42 55 |      | °C/W |  |
| Maximum Junction-to-Case (Drain) | R <sub>thJC</sub> | 0.72                    | 0.96 | G/VV |  |

| PARAMETER   | SYMBOL                | TES   | T CONDITIONS  | MIN. | TYP.  | MAX.  | UNIT |
|---|-----------------------|---|---|------|-------|-------|------|
| Static  |                       |   |   |      |       | l     |      |
| Drain-Source Breakdown Voltage                            | V <sub>DS</sub>       | V <sub>GS</sub> =   | = 0 V, I <sub>D</sub> = 250 μA  | 650  | -     | -     | V    |
| V <sub>DS</sub> Temperature Coefficient                   | $\Delta V_{DS}/T_{J}$ | Reference   | e to 25 °C, I <sub>D</sub> = 10 mA  | -    | 0.75  | -     | V/°C |
| Gate-Source Threshold Voltage (N)                         | V <sub>GS(th)</sub>   | V <sub>DS</sub> =   | V <sub>GS</sub> , I <sub>D</sub> = 250 μA                                       | 2.0  | -     | 4.0   | V    |
| Oala Oa aaalaalaa   |                       |   | $V_{GS} = \pm 20 \text{ V}$   | -    | -     | ± 100 | nA   |
| Gate-Source Leakage                                       | I <sub>GSS</sub>      | 1   | $V_{GS} = \pm 30 \text{ V}$   | -    | -     | ± 1   | μΑ   |
| Zana Oata Valta na Duain Oannant                          |                       | V <sub>DS</sub> =   | V <sub>DS</sub> = 520 V, V <sub>GS</sub> = 0 V                                  |      | -     | 1     |      |
| Zero Gate Voltage Drain Current                           | I <sub>DSS</sub>      | V <sub>DS</sub> = 520 V   | , V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C                                | -    | -     | 500   | μA   |
| Drain-Source On-State Resistance                          | R <sub>DS(on)</sub>   | V <sub>GS</sub> = 10 V  | I <sub>D</sub> = 6 A  | -    | 0.332 | 0.382 | Ω    |
| Forward Transconductance                                  | 9 <sub>fs</sub>       | V <sub>DS</sub>   | = 30 V, I <sub>D</sub> = 6 A  | -    | 4.6   | -     | S    |
| Dynamic   |                       |   |   |      |       |       |      |
| Input Capacitance   | C <sub>iss</sub>      |   | $V_{GS} = 0 V$  | -    | 1243  | -     |      |
| Output Capacitance  | C <sub>oss</sub>      | ١ ,   | V <sub>DS</sub> = 100 V,  | -    | 62    | -     |      |
| Reverse Transfer Capacitance                              | C <sub>rss</sub>      |   | f = 1 MHz   | -    | 4     | -     |      |
| Effective Output Capacitance, Energy Related <sup>a</sup> | C <sub>o(er)</sub>    | ٧, ٥١   | /+- 500 V V 0 V   | -    | 44    | -     | pF   |
| Effective Output Capacitance, Time Related <sup>b</sup>   | C <sub>o(tr)</sub>    | V <sub>DS</sub> = 0 \   | / to 520 V, V <sub>GS</sub> = 0 V   | -    | 171   | -     |      |
| Total Gate Charge   | Qg                    |   |   | -    | 35    | 70    |      |
| Gate-Source Charge  | Q <sub>gs</sub>       | V <sub>GS</sub> = 10 V  | $I_D = 6 A, V_{DS} = 520 V$   | -    | 8     | -     | nC   |
| Gate-Drain Charge   | $Q_{gd}$              |   |   | -    | 15    | -     |      |
| Turn-On Delay Time  | t <sub>d(on)</sub>    |   |   | -    | 19    | 38    |      |
| Rise Time   | t <sub>r</sub>        | V <sub>DD</sub> =   | = 520 V, I <sub>D</sub> = 6 A,  | -    | 26    | 52    |      |
| Turn-Off Delay Time                                       | t <sub>d(off)</sub>   |   | $= 10 \text{ V}, \text{ R}_{\text{g}} = 9.1 \Omega$                             | -    | 43    | 86    | ns   |
| Fall Time   | t <sub>f</sub>        |   |   | -    | 25    | 50    |      |
| Gate Input Resistance                                     | R <sub>g</sub>        | f = 1   | MHz, open drain   | 0.4  | 0.7   | 1.4   | Ω    |
| Drain-Source Body Diode Characteristic                    | s                     |   |   |      |       |       |      |
| Continuous Source-Drain Diode Current                     | I <sub>S</sub>        | MOSFET sym showing the  | MOSFET symbol showing the   |      | -     | 11    | A    |
| Pulsed Diode Forward Current                              | I <sub>SM</sub>       | integral reverse<br>p - n junction diode                            |   | -    | -     | 21    |      |
| Diode Forward Voltage                                     | $V_{SD}$              | T <sub>J</sub> = 25 °C, I <sub>S</sub> = 6 A, V <sub>GS</sub> = 0 V |   | -    | 0.9   | 1.2   | V    |
| Reverse Recovery Time                                     | t <sub>rr</sub>       | _   |   | -    | 108   | 216   | ns   |
| Reverse Recovery Charge                                   | Q <sub>rr</sub>       |   | 5 °C, I <sub>F</sub> = I <sub>S</sub> = 6 A,<br>100 A/µs, V <sub>B</sub> = 25 V | -    | 0.5   | 1.0   | μC   |
| Reverse Recovery Current                                  | I <sub>RRM</sub>      |   | 100 Ανμο, νΗ = 20 ν   | -    | 9.6   | -     | Α    |

#### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .
- b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

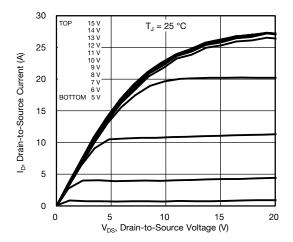


Fig. 1 - Typical Output Characteristics

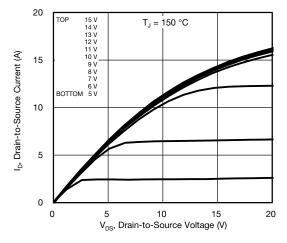


Fig. 2 - Typical Output Characteristics

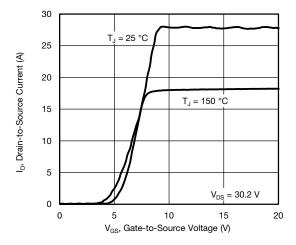


Fig. 3 - Typical Transfer Characteristics

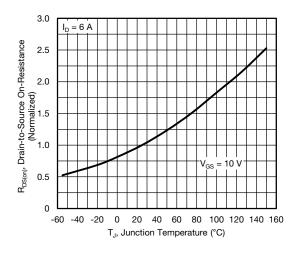


Fig. 4 - Normalized On-Resistance vs. Temperature

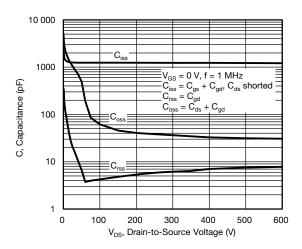


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

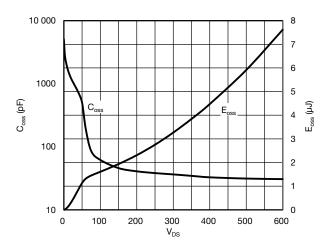


Fig. 6 -  $C_{\mbox{\scriptsize OSS}}$  and  $E_{\mbox{\scriptsize OSS}}$  vs.  $V_{\mbox{\scriptsize DS}}$ 



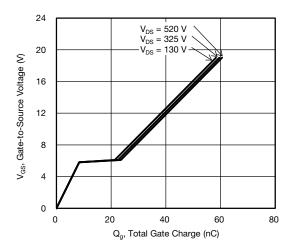


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

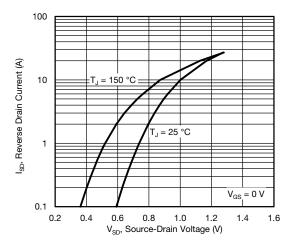


Fig. 8 - Typical Source-Drain Diode Forward Voltage

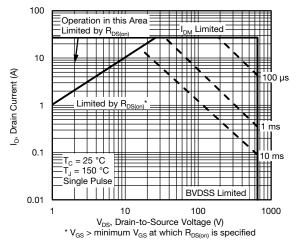


Fig. 9 - Maximum Safe Operating Area

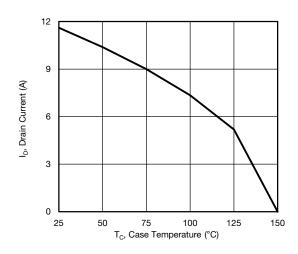


Fig. 10 - Maximum Drain Current vs. Case Temperature

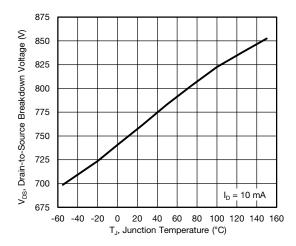


Fig. 11 - Temperature vs. Drain-to-Source Voltage



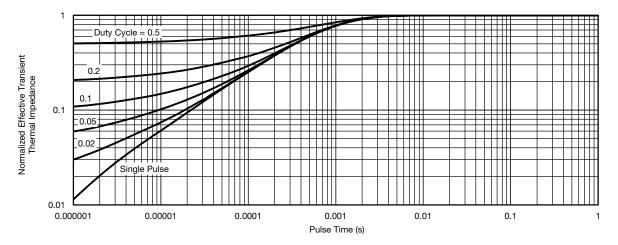


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

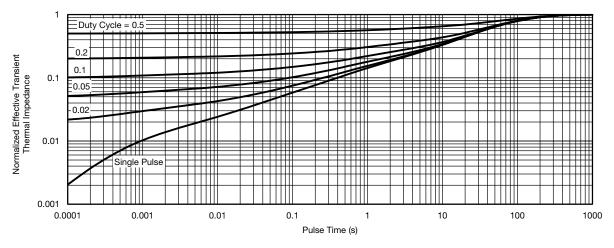


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

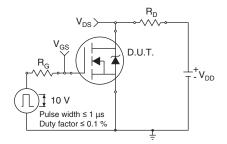


Fig. 14 - Switching Time Test Circuit

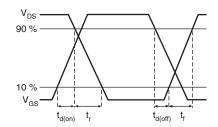


Fig. 15 - Switching Time Waveforms



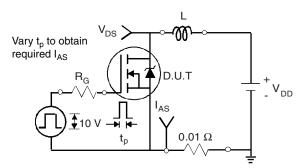


Fig. 16 - Unclamped Inductive Test Circuit

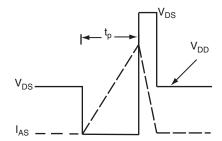


Fig. 17 - Unclamped Inductive Waveforms

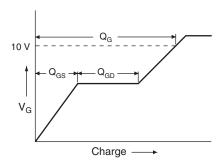


Fig. 18 - Basic Gate Charge Waveform

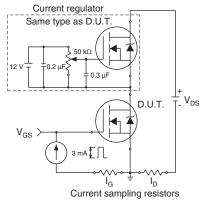
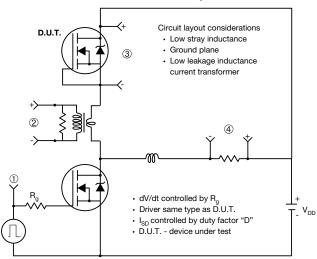


Fig. 19 - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



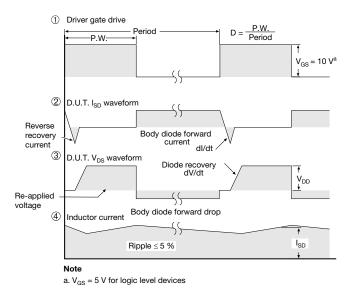


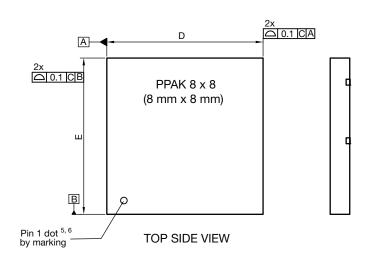
Fig. 20 - For N-Channel

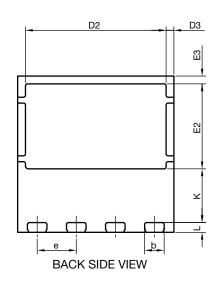
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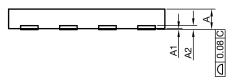


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# PowerPAK® 8 x 8 Case Outline







| DIM.             | MILLIMETERS |          | INCHES    |                    |       |       |
|------------------|-------------|----------|-----------|--------------------|-------|-------|
| DIIVI.           | MIN.        | NOM.     | MAX.      | MIN.               | NOM.  | MAX.  |
| Α                | 0.95        | 1.00     | 1.05      | 0.037              | 0.039 | 0.041 |
| A1               | 0.00        | -        | 0.05      | 0.000              | -     | 0.002 |
| A2               |             | 020 ref. |           | 0.008 ref.         |       |       |
| b                | 0.95        | 1.00     | 1.05      | 0.037              | 0.039 | 0.041 |
| D                | 7.90        | 8.00     | 8.10      | 0.311              | 0.315 | 0.319 |
| D2               | 7.10        | 7.20     | 7.30      | 0.280              | 0.283 | 0.287 |
| D3               | 0.40 BSC    |          |           | 0.016 BSC          |       |       |
| е                | 2.00 BSC    |          | 0.079 BSC |                    |       |       |
| E                | 7.90        | 8.00     | 8.10      | 0.311              | 0.315 | 0.319 |
| E2               | 4.30        | 4.35     | 4.40      | 0.169              | 0.171 | 0.173 |
| E3               | 0.40 BSC    |          |           | 0.40 BSC 0.016 BSC |       |       |
| K                | 2.75 BSC    |          | 0.108 BSC |                    |       |       |
| L                | 0.45        | 0.50     | 0.55      | 0.018              | 0.020 | 0.022 |
| N <sup>(3)</sup> | 8           |          |           |                    | 8     |       |

#### Notes

- (1) Use millimeters as the primary measurement
- (2) Dimensioning and tolerances conform to ASME Y14.5 M 1994
- (3) N is the number of terminals
- (4) The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body
- (5) Exact shape and size of this feature is optional

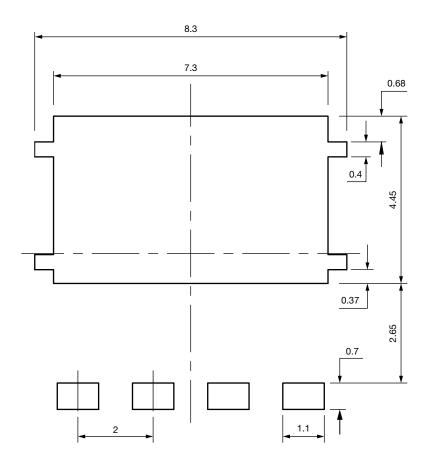
ECN: E20-0518-Rev. B, 28-Sep-2020

DWG: 6041

Revision: 28-Sep-2020 1 Document Number: 67859



# Recommended Minimum PADs for PowerPAK® 8 mm x 8 mm



Dimensions in millimeters



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